

Dual P-Channel 30-V (D-S) MOSFET

G1 0

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^{d, e}	Q _g (Typ.)			
- 30	0.029 at V _{GS} = - 10 V	- 7.3	17 nC			
	0.039 at V _{GS} = - 4.5 V	- 6.3	17110			

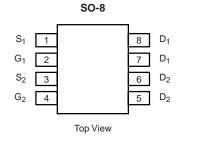
FEATURES

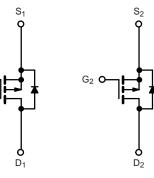
- Halogen-free
- TrenchFET[®] Power MOSFET
- 100 % UIS Tested

APPLICATIONS

Load Switches







P-Channel MOSFET

P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T	A = 25 °C, unless othe	erwise noted			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	- 30	V		
Gate-Source Voltage	V _{GS}	± 20			
	T _C = 25 °C		- 7.3 ^e		
Continuous Drain Current ($T_1 = 150 \text{ °C}$)	T _C = 70 °C		- 7.0 ^e		
Continuous Drain Current (1j = 150°C)	T _A = 25 °C	I _D	- 7.3 ^{a, b}		
	T _A = 70 °C		- 5.9 ^{a, b}	Α	
Pulsed Drain Current	I _{DM}	- 32 ^e	A		
Ossiliano Ossila Dista Ossila	T _C = 25 °C	L.	- 4.1		
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	- 2.0 ^{a, b}		
Avalanche Current	L = 0.1 mH	I _{AS}	- 20		
Single-Pulse Avalanche Energy		E _{AS}	20	mJ	
	T _C = 25 °C		5.0		
Maximum Dowar Dissinction	T _C = 70 °C	P _D	3.2	w	
Maximum Power Dissipation	T _A = 25 °C	r D	2.5 ^{a, b}	VV	
	T _A = 70 °C	1	1.6 ^{a, b}		
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{a, c}	t ≤ 10 s	R _{thJA}	38	50	°C/W	
Maximum Junction-to-Foot	Steady State	R _{thJF}	20	25	C/W	

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. t = 10 s.

c. Maximum under Steady State conditions is 85 $^{\circ}\text{C/W}.$

d. Based on T_C = 25 °C.

e. Limited by package.

SPECIFICATIONS $T_J = 25 \degree C$ Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static	Symbol	Test conditions		тур.	IVIAX.	Unit
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = - 250 μA	- 30			V
V _{DS} Temperature Coefficient	ΔV _{DS} /T _J	VGS = 0 V, ID = - 250 μΛ	- 30	21		v
		I _D = - 250 μA		- 31 4.5		mV/°C
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	V _{DS} = V _{GS} , I _D = - 250 μA	1.0	4.5	2.0	V
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \mu A$ $V_{DS} = 0 V, V_{GS} = \pm 20 V$	- 1.0		- 3.0	-
Gate-Source Leakage	I _{GSS}				± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ $V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 \text{ °C}$			- 1 - 5	μA
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge$ - 10 V, V_{GS} = - 10 V	- 30			A
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = -10 \text{ V}, \text{ I}_{D} = -6.3 \text{ A}$ $V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -6.2 \text{ A}$		0.035 0.040		Ω
Forward Transconductance ^a	06	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -6.1 \text{ A}$		23		S
Dynamic ^b	9 _{fs}	VDS = 10 V, 10 = 0.1 / 1		25		5
Input Capacitance	C _{iss}			1350		
Output Capacitance	C _{oss}	V _{DS} = - 15 V, V _{GS} = 0 V, f = 1 MHz		215		nE
Reverse Transfer Capacitance		$v_{\rm DS} = 13$ v, $v_{\rm GS} = 0$ v, $1 = 10002$				pF
Reverse mansier Capacitance	C _{rss}	V _{DS} = - 15 V, V _{GS} = - 10 V, I _D = - 6.1 A		185	50	
Total Gate Charge	Qg	$v_{\rm DS} = -13 v$; $v_{\rm GS} = -10 v$; $v_{\rm D} = -0.1 A$		32 15	50 25	nC
Cata Source Charge	0	V _{DS} = - 15 V, V _{GS} = - 4.5 V, I _D = - 6.1 A		4	20	
Gate-Source Charge Gate-Drain Charge	Q _{gs} Q _{qd}	$v_{\rm DS} = -13 v, v_{\rm GS} = -4.3 v, i_{\rm D} = -0.1 A$		7.5		
Gate Resistance	U U	f = 1 MHz		5.8		Ω
	R _g	I = I MHZ		5.8 10	15	52
Turn-On Delay Time Rise Time	t _{d(on)}	V _{DD} = - 15 V, R _I = 15 Ω		8	15	_
	t _r	$V_{DD} = -15 V, R_L = 15 \Omega$ $I_D \cong -1 A, V_{GEN} = -10 V, R_a = 1 \Omega$		ہ 45	70	
Turn-Off DelayTime	t _{d(off)}	$D = -1 A$, $V_{GEN} = -10 V$, $N_g = 1.52$		45 12	25	
Fall Time	t _f			42	25 70	ns
Turn-On Delay Time	t _{d(on)}	V - 15 V B - 15 O		42 35	60	
Rise Time	t _r	$V_{DD} = -15 \text{ V}, \text{ R}_{L} = 15 \Omega$				
Turn-Off DelayTime	t _{d(off)}	$I_D \cong$ - 1 A, V_{GEN} = - 4.5 V, R_g = 1 Ω		40	70	
Fall Time	t _f			16	30	
Drain-Source Body Diode Characterist	1	T 05 00		[
Continous Source-Drain Diode Current	I _S	T _C = 25 °C			- 4.1	A
Pulse Diode Forward Current	I _{SM}			0.75	- 32	
Body Diode Voltage	V _{SD}	$I_{S} = -2 A, V_{GS} = 0 V$		- 0.75	- 1.2	V
Body Diode Reverse Recovery Time	t _{rr}			34	60	ns
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = - 2 A, dl/dt = 100 A/μs, T _{.1} = 25 °C		22	40	nC
Reverse Recovery Fall Time	t _a	······································		11		ns
Reverse Recovery Rise Time	t _b			23		

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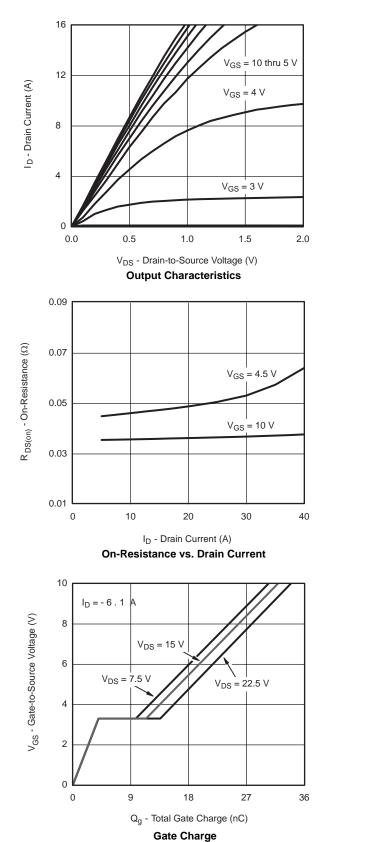
Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

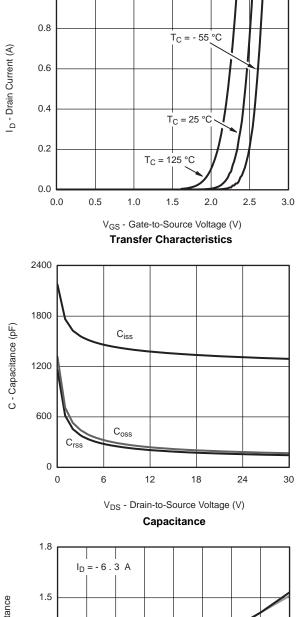
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

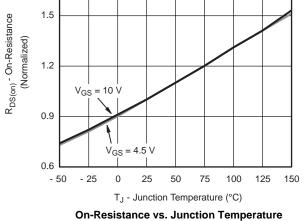




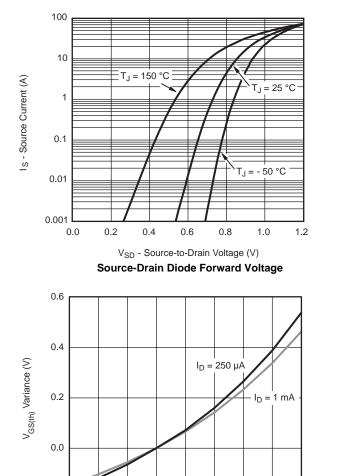
TYPICAL CHARACTERISTICS 25 C, unless otherwise noted



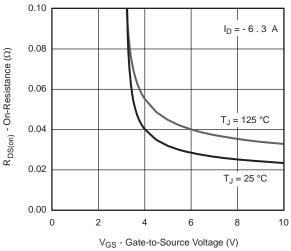
1.0



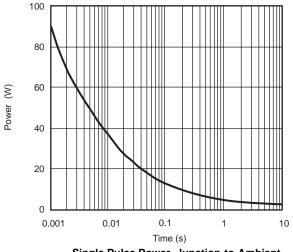




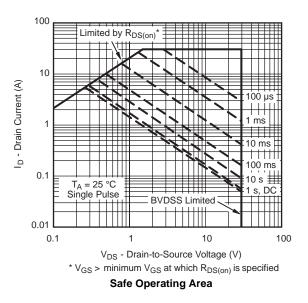
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



- 0.2

- 50

- 25

0

25

50

T_J - Temperature (°C)

Threshold Voltage

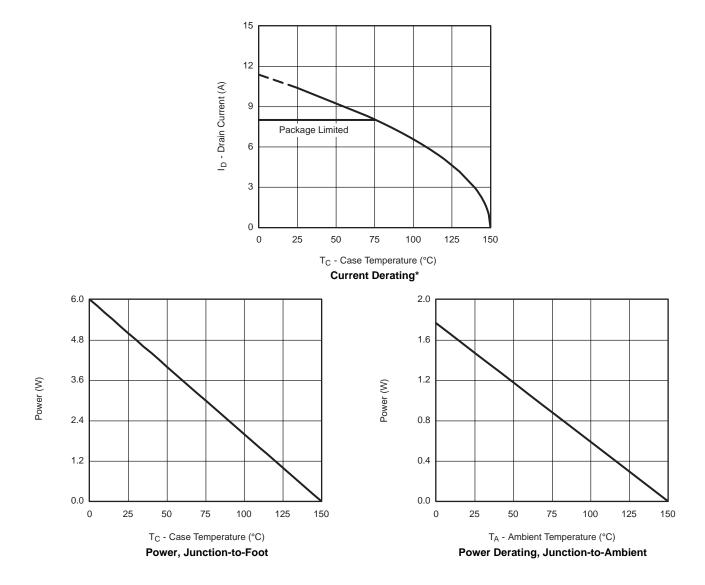
75

100

125 150



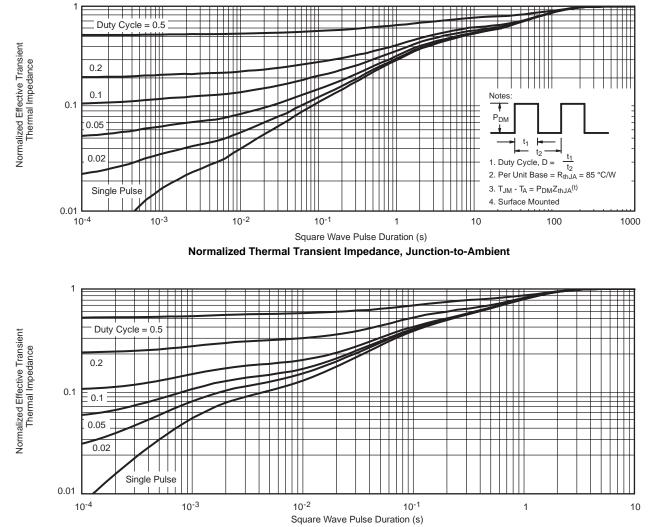
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

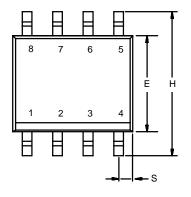


Normalized Thermal Transient Impedance, Junction-to-Foot



SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012

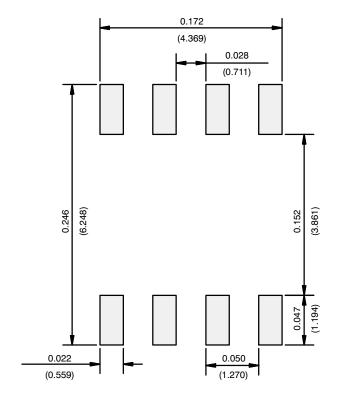




	MILLIM	IETERS	INCHES			
DIM	Min	Мах	Min	Max		
A	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
E	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050	0.050 BSC		
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498						



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)



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